

Form PTO-1595

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## RECORDATION FORM COVER SHEET

## PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE

U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Jana Hansel  
Matthias RudolphAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Execution Date: September 29, 2003

## 2. Name and address of receiving party(ies)

Name: Infineon Technologies AG

Internal Address: \_\_\_\_\_

Street Address: St.-Martin-Str. 53Munchen, GERMANY

City: \_\_\_\_\_ State: \_\_\_\_\_ Zip: \_\_\_\_\_

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_

A. Patent Application No.(s)

10/660,091

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Richard E. JenkinsInternal Address: Jenkins, Wilson & Taylor, P.A.University Tower, Suite 1400Street Address: 3100 Tower BoulevardCity: Durham State: NC Zip: 277076. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41).....\$ 40.00☐ Enclosed☒ Authorized to be charged to deposit account

## 8. Deposit account number:

50-0426

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## 9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Richard E. Jenkins

Name of Person Signing

Richard E. Jenkins

Signature

10-23-03

Date

Total number of pages including cover sheet, attachments, and documents: 3Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231

CH \$40.00 500426 10660091

PATENTAtty Docket: 1406/166ASSIGNMENT

WHEREAS, we, Jana Hänsel, of Dresden, Germany, and Matthias Rudolph, of Dresden, Germany, hereinafter ("Assignors"), have invented certain new and useful improvements in FABRICATION METHOD FOR A SEMICONDUCTOR STRUCTURE HAVING A PARTIALLY FILLED TRENCH for which application for a U.S. Letters Patent was made on September 10, 2003 as U.S. Patent Application Serial No. 10/660,091 (based on German application no. 10242629.5 filed September 13, 2002).

AND, WHEREAS, Infineon Technologies AG, a corporation duly organized and existing under the laws of Germany, having its principal office and place of business at St.-Martin-Str. 53, 81669 München, Germany (hereinafter "Assignee"), is desirous of acquiring an interest therein.

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors have sold and by these presents do hereby sell, assign, transfer and convey unto the said Assignee, its successors and assigns, their entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with their right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said Assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by Assignors if this assignment and sale had not been made.

Assignors hereby request that said Letters Patent be issued in accordance with this assignment.

Assignors further covenant and agree that, at the time of the execution and delivery of these presents, Assignors possess full title to the invention and application above-mentioned, and that they have the unencumbered right and authority to make this assignment.

Assignors further covenant and agree, and likewise bind their heirs, legal representatives and assigns, to promptly communicate to said Assignee or its representatives any facts known to them relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the Assignee, its representatives, successors and assigns to secure patent or similar protection for the said invention in all countries and to vest in the Assignee complete title to the said invention and Letters Patent, without further

compensation, but at the expense of said Assignee, its successors, assigns and other legal representatives.

Executed this 29 day of September 2003.

Jana Hinsel  
Jana Hinsel

Witnessed by:

M. Lohard 1.10.03  
Name Date

Angel Hecker 01.10.2003  
Name Date

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Executed this 29 day of September 2003.

Matthias Rudolph  
Matthias Rudolph

Witnessed by:

M. Lohard 1.10.03  
Name Date

Angel Hecker 01.10.2003  
Name Date